

EMI6316FCTBG

EMI Filter with ESD Protection for MicroSD Card Applications

Product Description

The EMI6316 is a 4 x 4, 15-bump EMI filter with ESD protection device for MicroSD card applications in a 0.4 mm pitch CSP form factor. It is fully compliant with IEC 61000-4-2. The EMI6316 is also RoHS II compliant.



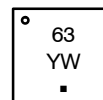
ON Semiconductor®

<http://onsemi.com>

MARKING DIAGRAM



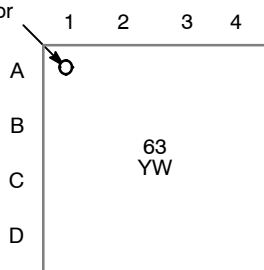
WLCSP15
CASE 567FX



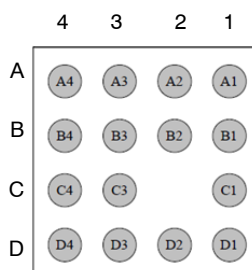
63 = Specific Device Code
Y = Year
W = Work Week
▪ = Pb-Free Package

PACKAGE / PINOUT DIAGRAMS

A1 Corner Indicator



Top View
(Bumps Down View)



Bottom View
(Bumps Up View)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 3 of this data sheet.

EMI6316FCTBG

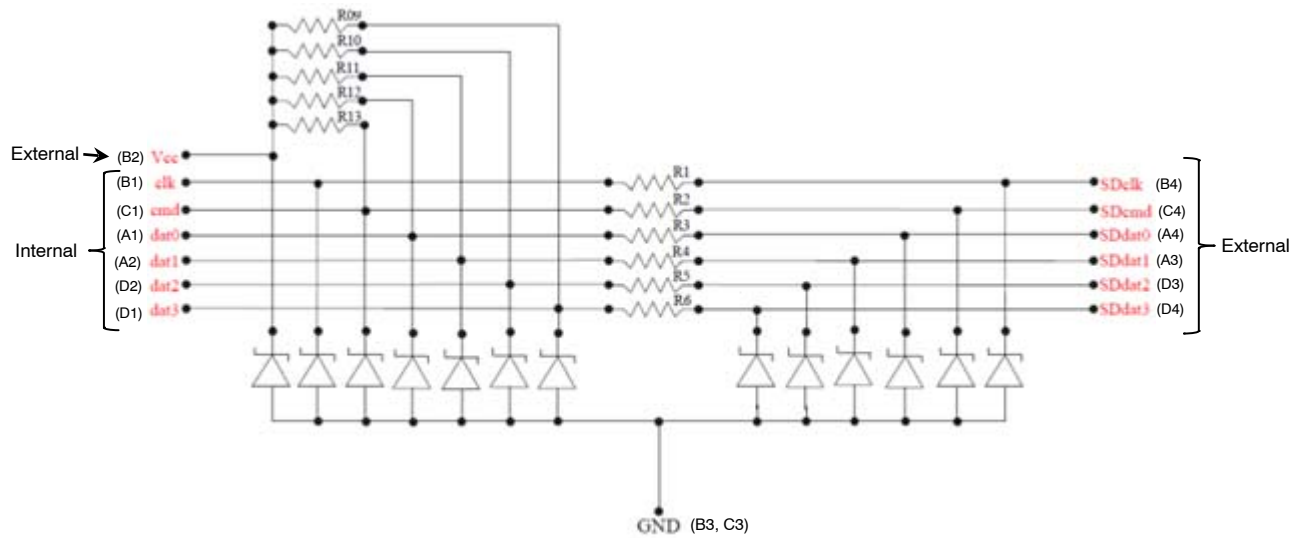


Figure 1. Electrical Schematic

Table 1. PIN DESCRIPTIONS

Pin	Description	Pin	Description	Pin	Description	Pin	Description
A1	dat0 Internal	B1	clk Internal	C1	cmd Internal	D1	data3 Internal
A2	dat1 Internal	B2	V _{CC} External			D2	data2 Internal
A3	SDdat1 External	B3	GND	C3	GND	D3	SDdata2 External
A4	SDdat0 External	B4	SDclk External	C4	SDcmd External	D4	SDdata3 External

EMI6316FCTBG

ELECTRICAL SPECIFICATIONS AND CONDITIONS

Table 2. PARAMETERS AND OPERATING CONDITIONS

Parameter	Rating	Unit
Storage Temperature Range	-55 to +150	°C
Operating Temperature Range	-40 to +85	°C

Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
R ₁ R ₂ R ₃ R ₄ R ₅ R ₆	Resistance		34	40	46	Ω
R ₉ R ₁₀ R ₁₁ R ₁₂	Resistance		42.5	50	57.5	kΩ
R ₁₃	Resistance		12.75	15	17.25	kΩ
I _{LEAK}	Leakage Current per Channel	V _{IN} = 3.0 V		10	100	nA
C	Line Capacitance	At 1 MHz, V _{IN} = 0 V	9	11.5	14	pF
		At 1 MHz, V _{IN} = 1.8 V (Note 2)		8		pF
		At 1 MHz, V _{IN} = 2.5 V		7		pF
V _B	Breakdown Voltage (Positive)	I _R = 1 mA	6	7	9	V
V _{ESD}	ESD Protection Peak Discharge Voltage at A3, A4, B2, B4, C4, D3 and D4 pins a) Contact Discharge per IEC 61000-4-2 standard b) Air Discharge per IEC 61000-4-2 standard	(Note 3)	±8 ±15			kV
	ESD Protection Peak Discharge Voltage at A1, A2, B1, C1, D1 and D2 pins a) Contact Discharge per IEC 61000-4-2 standard b) Air Discharge per IEC 61000-4-2 standard	(Note 3)	±2 ±2			

1. All parameters specified at T_A = 25°C unless otherwise noted.
2. MicroSD version 3.0 SDR104 compliant.
3. Standard IEC 61000-4-2 with C_{Discharge} = 150 pF, R_{Discharge} = 330 Ω.

Table 4. CSP TAPE AND REEL SPECIFICATIONS†

Part Number	Chip Size (mm)	Package	Shipping†
EMI6316FCTBG	1.56 x 1.56 x 0.50	WLCSP15 (Pb-Free)	5000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

RF CHARACTERISTICS

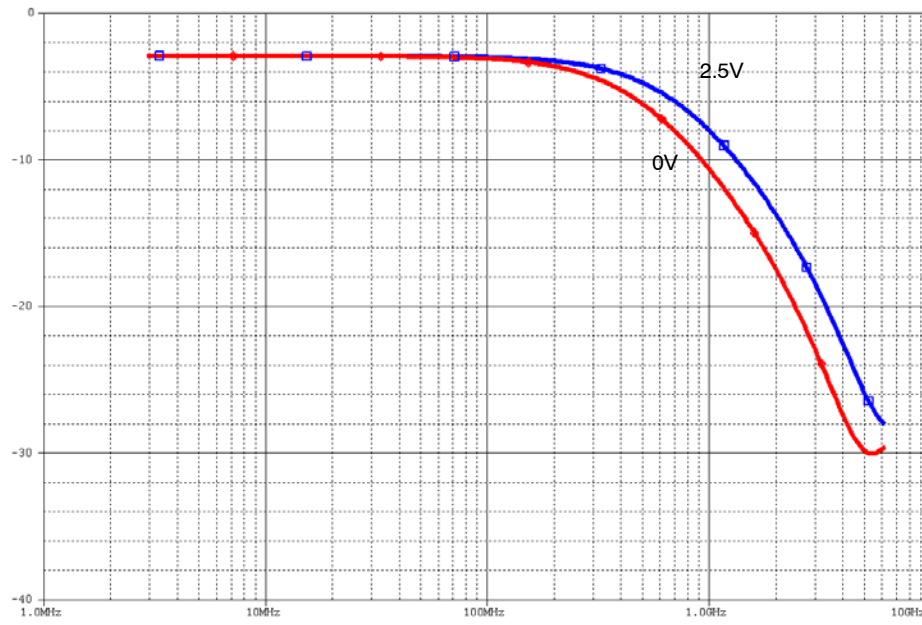


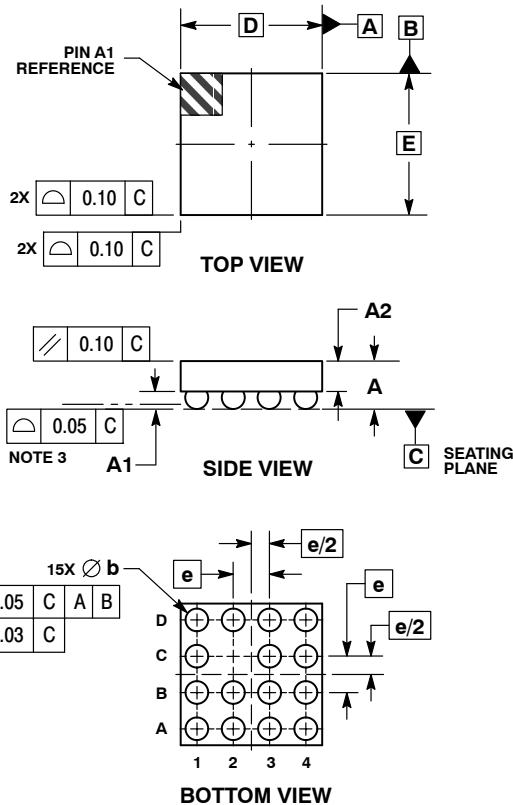
Figure 2. S21 Attenuation Simulation



SCALE 4:1

WLCSP15, 1.56x1.56
CASE 567FX
ISSUE O

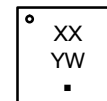
DATE 07 JUN 2012



NOTES:

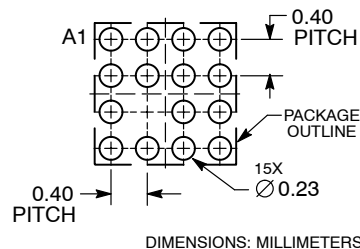
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.47	0.53
A1	0.185	0.205
A2	0.305 REF	
b	0.24	0.29
D	1.56 BSC	
E	1.56 BSC	
e	0.40 BSC	

GENERIC MARKING DIAGRAM*


XX = Specific Device Code
Y = Year
W = Work Week
▪ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "▪", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*


*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON81359E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	WLCSP15, 1.56X1.56	PAGE 1 OF 1

onsemi and **onsemi** are trademarks of Semiconductor Components Industries, LLC dba **onsemi** or its subsidiaries in the United States and/or other countries. **onsemi** reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. **onsemi** does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at
www.onsemi.com/support/sales

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[onsemi:](#)

[EMI6316FCTBG](#)